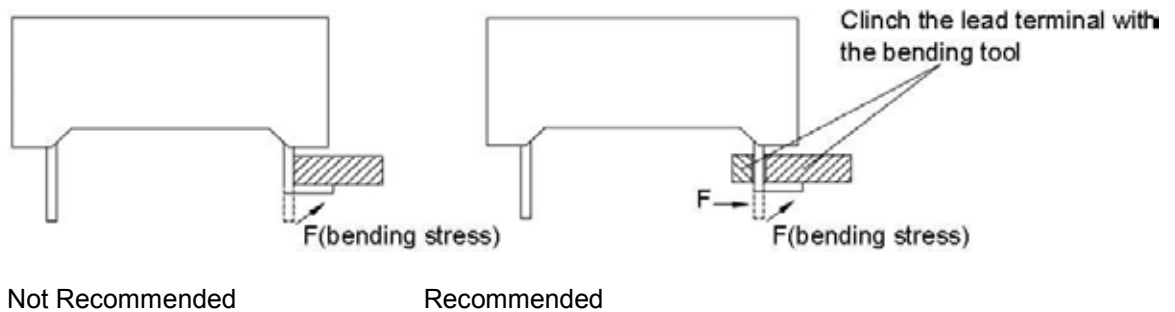


### THROUGH HOLE DISPLAY MOUNTING METHOD

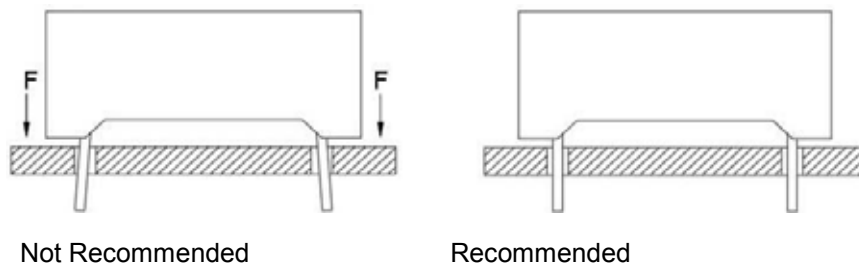
#### Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

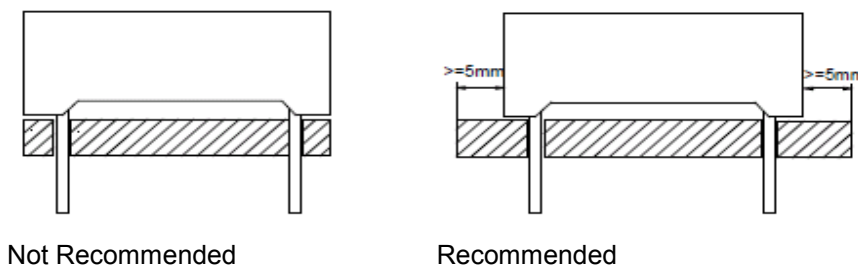


#### Installation

1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

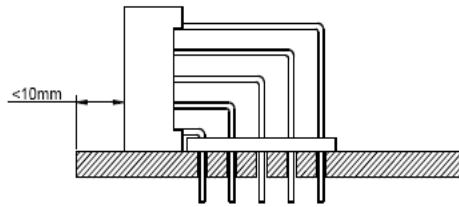


3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering

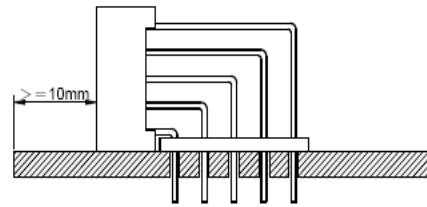


4. When performing automated mounting, board bending, and lead-trimming or clinching operations, the stress may damage the resin body. In particular, caution should be taken when clinching or cutting the leads, since the amount of force applied during this time is significant. Therefore, test samples should be run through the lead-forming process then pass through soldering to be check for possible damage before mass production begins.

5. For products with 90-degree lead bends, Kingbright recommends at least 10mm of clearance between the display and the edge of the PCB during soldering and assembly.



Not Recommended



Recommended

### DISPLAY SOLDERING CONDITIONS

The recommended conditions for soldering are as follows. Because the component is made with epoxy resin, the units are susceptible to heat. Therefore, the preheating and soldering temperatures should be kept as low as possible to avoid damage.

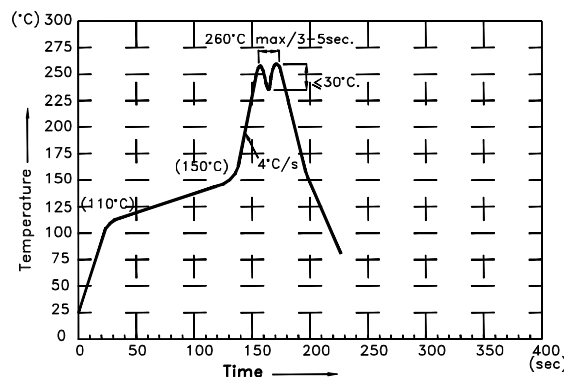
#### 1 . Manual Soldering Conditions(with 1.5mm Iron tip )

Iron Tip Temperature: 350°C Max, Time: 3s Max

Position: The iron should be situated at least 2mm away from the root of the leads.

#### 2 . Through the Wave Soldering Conditions

Wave Soldering Profile For Lead-free Through-hole LED

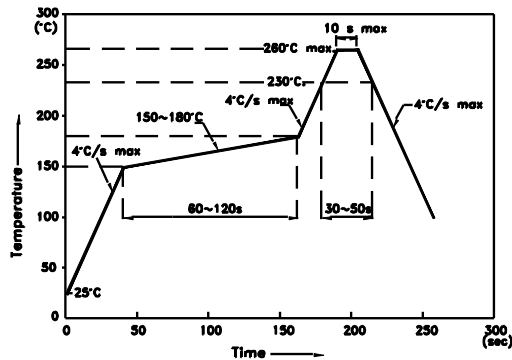


#### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
- 5.No more than once.

### 3. Reflow soldering Profile for SMD Display

Reflow Soldering Profile For Lead-free SMT Process.



**NOTES:**

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### 4. Soldering General Notes:

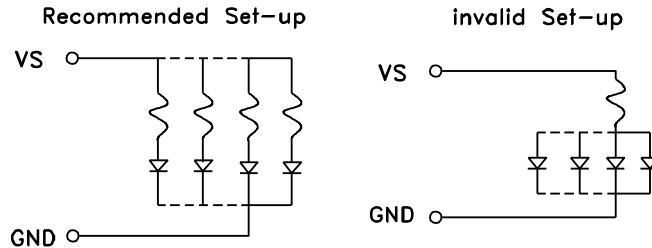
1. Kingbright recommend manual soldering to be used only for repair and rework purposes. The soldering iron should not exceed 30W in power. The tip of the soldering iron should not touch the reflector case to avoid heat-damage.
2. Maintain the pre-heat and peak temperatures with dip units as low as possible and the times as short as is feasible, since the products are susceptible to heat during flow soldering.
3. After soldering, allow at least three minutes for the component to cool to room temperature before further operations.
4. Through-hole displays are incompatible with reflow soldering.
5. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

### CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts.
3. The cleaning process should take place at room temperature and the devices should not be washed for more than one minute .
4. When water is used in the cleaning process, immediately remove excess moisture from the component with forced-air drying afterwards.

### CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



3. The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
4. The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
5. Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.

### ESD PROTECTION DURING PRODUCTION

Static discharge can result when static-sensitive products come in contact with the operator or other conductors. The following procedures may decrease the possibility of ESD damage.

1. Minimize friction between the product and surroundings to avoid static buildup.
2. All production machinery and test instruments must be electrically grounded.
3. Operator must wear anti-static bracelets.
4. Wear anti-static suit when entering work areas with conductive machinery.
5. Set up ESD protection areas with grounded mats for component handling.
6. All workstations that handle IC and ESD-sensitive components must maintain an electrostatic potential of 150V or less.
7. Maintain a humidity level of 50% or higher in production areas.
8. Use anti-static packaging for transport and storage.
9. All anti-static equipment and procedures should be periodically inspected and evaluated for proper functionality.

### STORAGE CONDITIONS

1. The LEDs should not be exposed to an environment where high level of moisture or corrosive gases are present.

#### 2. LED Display Standard Storage Condition

Temperature Condition: 5°C ~ 30°C

Humidity Condition: Below 60%RH

#### 3. LED SMD Display Standard Storage Condition

When the package is in factory original sealed bag

Temperature Condition: 5°C ~ 30°C

Humidity Condition: Below 60%RH

When the package is opened and not in factory original sealed bag

Temperature Condition: 5°C ~ 30°C

Humidity Condition: Below 60%RH

Storage time: Within 4 weeks (MSL as level 2a)

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